504394663 06/02/2017

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHANG-MING WU	03/24/2014
WEI-CHENG WU	03/24/2014
YUAN-TAI TSENG	03/24/2014
SHIH-CHANG LIU	03/24/2014
CHIA-SHIUNG TSAI	03/24/2014
RU-LIANG LEE	03/24/2014
HARRY HAK-LAY CHUANG	03/24/2014

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.	
Street Address:	NO.8, LI-HSIN RD.6	
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK	
City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	300	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15607337

CORRESPONDENCE DATA

Fax Number: (435)252-1360

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 4352521360
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Correspondent Name: R. BURNS ISRAELSEN
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ATTORNEY DOCKET NUMBER:	T1516.10007US03
NAME OF SUBMITTER:	R. BURNS ISRAELSEN
SIGNATURE: /R. Burns Israelsen, Reg. No. 42685/	

504394663 REEL: 042572 FRAME: 0288

PATENT

DATE SIGNED: 06/02/2017

Total Attachments: 2
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PATENT REEL: 042572 FRAME: 0289

ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title)				
Embedded Nonvolatile Memory and Forming Method Thereof				
The PATENT RIGHTS referred to in this agreement are:				
(check one) a patent application for this invention, executed by the ASSIGNOR(S)				
concurrently with this assignment.				
☐U.S. patent application Serial No,filed				
a U.S. patent application based on PCT International Application				
Nofiled on (date)(U.S. patent application				
Serial No, if known).				
☐U.S. patent No, issued				
The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of				
the patents and patent applications identified above.				
The PATENT RIGHTS assigned under this agreement are:				
(check one) ⊠U.S. patent rights only.				
→ Worldwide patent rights. In this case, the assignee shall have the right to				
claim the benefit of the filing date of any U.S. or foreign patent application				
for this invention.				
The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures				
appear on page 2 of this Assignment and any Supplemental Sheet(s).				
The ASSIGNEE referred to in this agreement is:				
(Name of Assignee) TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.				
(Address) NO.8, LI-HSIN RD.6, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU,				
TAIWAN 300, R.O.C.				
The ASSIGNEE is:				
(check one) An individual.				
☐A Partnership.				
A Corporation of <u>TAIWAN, R.O.C.</u> (specify state or country)				
□(other)				
The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and				
valuable consideration, receipt of which is acknowledged, hereby assign(s) the following				
rights to the ASSIGNEE, its successors and assigns:				
the full and exclusive right to the invention;				
the entire right, title and interest in and to the PATENT RIGHTS;				
the right to sue and recover for any past infringement; and				
the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable				
provisions, based on any earlier patent applications for this invention.				

PATENT REEL: 042572 FRAME: 0290 THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO ASSIGNEE: TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD, INVENTION TITLE: Embedded Nonvolatile Memory and Forming Method Thereof

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

Chang-Ming WU	CRAM - MAN W.	3/24/2014
Name of sole or first inventor	Signature	Date
Wei-Cheng WU	Wei Changle	n <u>3/24/201</u> 4
Name of second inventor, if any	Signature	Date
Yuan-Tai TSENG	grow try	3/24/2014
Name of third inventor, if any	Signature	Date
Shih-Chang LIU	Shih-change	in 3/24/2014.
Name of fourth inventor, if any	Signature	Date
Chia-Shiung TSAI	clin Shing Te	3/26 hors
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Name of sixth inventor, if any	Signature /	Date
Harry Hak-Lay CHUANG		3/20/2014
Name of seventh inventor, if any	Signature	Date

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RECORDED: 06/02/2017